MPQ3367A

Low-EMI, 6-Channel, Max 150mA/Ch Boost WLED Driver with 15000:1 Dimming Ratio and I ²C, AEC-Q100

DESCRIPTION

The MPQ3367A is a step-up converter with 6 channel current sources. The device is designed to drive the white LED arrays as backlighting for small- or medium-sized LCD panels.

The device uses peak current mode as its PWM control architecture to regulate the boost converter. Six channel current sources are applied to the LED cathode to adjust the LED brightness. The MPQ3367A regulates the current in each LED string to the value set by an external current-setting resistor, with 2.5% current matching between strings.

A low on resistance MOSFET and headroom voltage are provided to improve efficiency. The MPQ3367A has a standard I ²C digital interface for easy use. The switching frequency can be configured via a resistor, I ²C interface, or external clock.

The MPQ3367A provides analog, PWM, and mix dimming mode with a PWM input. The dimming mode can be selected with the I ²C interface or the MIX/AD pin. The device also has a phase shift function to improve or eliminate noise during PWM dimming.

Robust protections are included to guarantee safe operation of the device. Protection modes include over-current protection (OCP), overvoltage protection (OVP), over-temperature protection (OTP), LED short and open protection. The MPQ3367A can automatically decrease the LED current at high temperatures.

The MPQ3367A is available in a QFN-24 (4mmx4mm) package.

FEATURES

- 3.5V to 36V Input Voltage Range
- 6 Channels with Maximum 150mA per Channel
- Internal 100mΩ, 50V MOSFET
- Configurable f_{SW} up to 2.2MHz
- External Sync Switching Frequency Function
- Multi-Dimming Operation Mode through PWM Input, Including:
	- o Direct PWM Dimming
	- o Analog Dimming
	- o Mix Dimming with 25% or 12.5% Transfer Point
- 15000:1 Dimming Ratio in PWM Dimming Mode when $f_{\text{PWM}} \leq 200$ Hz
- 200:1 Dimming Ratio at Analog Dimming through PWM Dimming Signal Input
- Excellent EMI Performance, Frequency Spread Spectrum
- \bullet ²C Interface with 3 Selectable IC Addresses
- Phase Shift Function for PWM Dimming
- 2.5% Current Matching
- Cycle-by-Cycle Current Limit
- Disconnect VOUT from VIN
- Optional LED Current Auto-Decrease at High Temperatures
- LED Short/Open, OTP, OCP, and Inductor Short Protection
- Configurable LED Short Threshold
- Configurable OVP Threshold
- Fault Indicator Signal Output
- Available in a QFN-24 (4mmx4mm) Package
- Available in AEC-Q100 Grade 1

APPLICATIONS

- Tablets and Notebooks
- Automotive Displays

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TYPICAL APPLICATION

ORDERING INFORMATION

* For Tape & Reel, add suffix -Z (e.g. MPQ3367AGR–AEC1-Z).

* * For Tape & Reel, add suffix -Z (e.g. MPQ3367AGRE–AEC1-Z).

TOP MARKING (MPQ3367AGR-AEC1)

MPSYWW M3367A LLLLLL

MPS: MPS prefix Y: Year code WW: Week code M3367A: Part number LLLLLL: Lot number

TOP MARKING (MPQ3367AGRE-AEC1) MPSYWW M3367A

LLLLLL

E

MPS: MPS prefix Y: Year code WW: Week code M3367A: Part number LLLLLL: Lot number E: Wettable lead flank

PACKAGE REFERENCE

PIN FUNCTIONS

PIN FUNCTIONS *(continued)*

ABSOLUTE MAXIMUM RATINGS (1)

ESD Ratings

Recommended Operating Conditions (3)

Thermal Resistance (4) *θJA θJC*

QFN-24 (4mmx4mm)….…....…42…….9....°C/W

Notes:

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature, T $_{\textrm{\tiny{J}}}$ (MAX), the junction-toambient thermal resistance, θ_{JA} , and the ambient temperature, T_{A} . The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D $(MAX) = (T_J (MAX) - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation can cause excessive die temperature, and the regulator may go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

ELECTRICAL CHARACTERISTICS

V_{IN} = 12V, V_{EN} = 2V, T_J = -40°C to +125°C, typical value is at T_J = 25°C, unless otherwise noted.

ELECTRICAL CHARACTERISTICS *(continued)*

V_{IN} = 12V, V_{EN} = 2V, T_J = -40°C to +125°C, typical value is at T_J = 25°C, unless otherwise noted.

ELECTRICAL CHARACTERISTICS *(continued)*

V_{IN} = 12V, V_{EN} = 2V, T_{J} = -40°C to +125°C, typical value is at T_{J} = 25°C, unless otherwise noted.

Notes:

5) Matching is defined as the difference of the maximum to minimum current divided by 2 times the average current.

6) Not tested in production. Guaranteed by characterization.

I ²C-COMPATIBLE INTERFACE TIMING DIAGRAM

Sr = Repeated Start Condition

P = Stop Condition

TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = 12V, L = 22µH, LED = 6P12S, f_{SW} = 650kHz, I_{SET} = 50mA, T_A = 25°C, unless otherwise noted.

Start-Up through VIN Start-Up through EN

PWM Dimming $f_{\text{PWM}} = 20$ kHz, $D_{\text{PWM}} = 50\%$

TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

 V_{IN} = 12V, L = 22µH, LED = 6P12S, f_{SW} = 650kHz, I_{SET} = 50mA, T_A = 25°C, unless otherwise noted.

 Mix Dimming

 $f_{\text{PWM}} = f_{\text{(ILED)}} = 200 \text{Hz}$, $D_{\text{PWM}} = 10\%$, TP=25%

Phase Shift Function

 $f_{\text{PWM}} = 200$ Hz, PWM dimming, 6-channel

Mix Dimming

 $f_{\text{PWM}} = 200 \text{Hz}, f_{(\text{ILED})} = 23 \text{kHz}, D_{\text{PWM}} = 10\%,$ TP=25%

Frequency Spread Spectrum 1/100 of switching frequency

TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

 V_{IN} = 12V, L = 22µH, LED = 6P12S, f_{SW} = 650kHz, I_{SET} = 50mA, T_A = 25°C, unless otherwise noted.

Short Inductor Protection Short Diode Protection

CH1: VSW 20V/div. CH2: VSD 5V/div. CH3: I^L 5A/div. CH4: ILED 200mA/div. 200mA/div. 1ms/div. 1s/div.

Short VOUT to GND Protection Thermal Protection

FUNCTIONAL BLOCK DIAGRAM

Figure 1: Functional Block Diagram

OPERATION

The MPQ3367A is a configurable, constantfrequency, peak current mode step-up converter with up to 6 channels of regulated current sources to drive an array of white LEDs.

Internal 5V Regulator

The MPQ3367A includes an internal linear regulator (VCC). When V_{IN} exceeds 6V, this regulator outputs a 5V power supply to the internal MOSFET switch gate driver and the internal control circuitry. The VCC voltage (V_{CC}) drops to 0V when the chip shuts down. The chip remains disabled until V_{CC} exceeds the under-voltage lockout (UVLO) threshold.

System Start-Up

When enabled, the MPQ3367A checks the topology connection. The IC draws current from SD to turn on the input disconnect PMOS (if this PMOS is used). After a 500μs delay, the IC monitors the OVP pin to see if the output is shorted to GND. If the OVP voltage is below 100mV, the IC is disabled, and it latches off. The MPQ3367A then continues to check other safety limits (e.g. LED open, over-voltage protection). If all protection tests pass, the IC starts boosting the step-up converter.

The recommended start-up sequence is listed below:

- 1. VIN
- 2. EN
- 3. I^2C (optional)
- 4. PWM dimming signal

Step-Up Converter

The MPQ3367A employs peak current mode control to regulate the output power. At the beginning of each switching cycle, the internal clock turns on the internal N-channel MOSFET. In normal operation, the minimum turn-on time is about 100ns. A stabilizing ramp is added to the output of the current-sense amplifier to prevent sub-harmonic oscillations for duty cycles exceeding 50%. This result is fed into the PWM comparator. When the summed voltage reaches the output voltage of the error amplifier, the internal MOSFET turns off.

The output voltage of the internal error amplifier is an amplified signal of the difference between

the reference voltage (V_{REF}) and the feedback voltage (V_{FB}) . The converter automatically chooses the lowest active LEDx pin voltage to provide a sufficient output voltage to power all the LED arrays.

If V_{FB} drops below V_{REF} , the output of the error amplifier increases. Then more current flows through the MOSFET, which increases the power delivered to the output. This forms a closed loop that regulates the output voltage.

During light-load operation (e.g. when V_{OUT} is almost equal to V_{IN}), the switching frequency will be stretched down.

Dimming Control

The MPQ3367A provides analog, PWM, and mix dimming methods. The dimming mode can be set with the I ²C, or by connecting a different resistor at MIX/AD. The MIX/AD voltage can be calculated with Equation (1):

V _{MIX/AD} (mV) = 18 (μA) x R _{MIX/AD} (kΩ) (1)

Where V $_{MIX/AD}$ is the MIX/AD voltage and $R_{MIX/AD}$ is the MIX/AD resistor.

Mix Dimming Mode

The MPQ3367A works in mix dimming mode with a 25% or 12.5% transfer point (selected through the internal register).

The first method is to connect a resistor and set MIX/AD to a low level (<0.3V).

The second method is to float MIX/AD, and set the internal mode selection register (MODE1:0) to 00 through the I ²C.

A PWM dimming signal is applied to DIM. When the dimming duty exceeds 25%, the device uses analog dimming, and the LED current amplitude follows the PWM duty.

When the dimming duty is below 25%, the device uses PWM dimming (see Figure 2 on page 16). The LED current amplitude remains at 1/4 of the full-scale current, and the output dimming duty is 4 times the duty of the input PWM signal.

Figure 2: Mix Dimming with 25% Transfer Point

There are two options for the output dimming frequency when the device uses mix dimming: 200Hz (default), or 23kHz (no audible noise, but larger minimum dimming duty). The output dimming frequency is not related to the input PWM dimming frequency. The output dimming frequency is selected with the mix dimming output frequency selection bit through the I ²C. This function eliminates audible noise and improves the dimming performance when there is a small dimming ratio.

Direct PWM Dimming Mode

Connect a resistor to set MIX/AD to a middle level (0.5V to 0.8V), or float MIX/AD and set the internal mode selection register (MODE1:0) to 01 through the I ²C.

When a PWM signal is applied to DIM, the amplitude of the LED current remains at the LED full-scale current, and the LED current is chopped by the input PWM signal. The LED current duty follows the PWM input duty, and the LED current frequency is the same as the PWM input.

Analog Dimming Mode

Connect a resistor to set MIX/AD to a high level (1V to 1.3V), or float MIX/AD and set the internal mode selection register (MODE1:0) to 10 through the I ²C.

The PWM input signal is calculated by an internal counter. The amplitude of the LED current is equal to I_{SET} x D_{DIM} , where I_{SET} is the full-scale LED current, and D_{DIM} is the duty of the input PWM signal.

Analog dimming supports a 200:1 dimming ratio.

Deep Dimming Ratio for PWM Dimming

When the output dimming on time is shorter than 7 μ s, V_{OUT} is regulated to be 93% of the OVP voltage (see Figure 3).

Figure 3: Deep Dimming Ratio for PWM Dimming

Unused LED Channel Setting

If an unused LEDx pin is connected to GND, the MPQ3367A can automatically detect it and remove it from the control loop during start-up. For example, if five strings are used, connect the LED6 pin to GND. If four strings are used, connect the LED5 and LED6 pins to GND.

The MPQ3367A can also disable the unused string via internal register (CH2:0), described in greater detail below:

- \bullet CH2:0 = 000: All 6 channels are in use
- CH2:0 = 001: LED1~5 are in use
- \bullet CH2:0 = 010: LED1~4 are in use
- CH2:0 = 011: LED1 \sim 3 are in use
- CH2:0 = 100: LED1~2 are in use
- CH2:0 = 101: LED1 is in use

Phase Shift Function

To reduce inrush current and eliminate audible noise during PWM dimming, the MPQ3367A employs a phase shift function.

Two methods can be used to enable the phase shift function. The first method is to connect SCL/PSE and SDA/PSE together, and set them between 0.75V and 1V. The second method is to set the internal register PSE bit to 1 through the l^2C .

The LED channels' current source are phase shifted when the IC employs PWM dimming. The shifted phase depends on how many LED channels are in use.

The phase shift can be calculated with Equation (2):

$$
Phase(^{\circ}) = \frac{360}{n} (^{\circ})
$$
 (2)

Where n is the number of LED channels being used. For example, if all six channels are in use, the shifted phase is 60°. LED1 directly follows the internal calculated PWM signal PWMI, and LED2 lags 60° behind (see Figure 4).

Figure 4: Phase Shift with 6 Channels

Figure 5 shows the phase shift function when four channels are enabled. In this case, the phase shift is 90°.

Figure 5: Phase Shift with 4 Channels

In phase shift operation, the channels must be disabled in descending order of channel number. For example, if three strings are employed in an application, then channels 6, 5, and 4 are disabled.

It is not recommended to tie two channels to 1 LED string when the phase shift function is enabled.

Frequency Spread Spectrum

The MPQ3367A uses switching frequency jitter to spread the switching frequency spectrum. This reduces the spectrum spike around the switching frequency and its harmonic frequencies.

The frequency jitter range is selected by the FSPR bit.

- When $FSPR = 0$ (default), the frequency jitter range is 1/10 of the switching frequency.
- When FSPR = 1, the frequency jitter range is 1/16 of the switching frequency.

The modulation frequency is selected by the FSPMF1:0 bits.

- When FSPMF1:0 = 00, the modulation frequency is 1/100 of the switching frequency.
- When $FSPMF1:0 = 01$, the modulation frequency is 1/150 of the switching frequency.
- When FSPMF1:0 = 10, the modulation frequency is 1/200 of the switching frequency.
- When FSPMF1:0 = 11 (default), this function is disabled.

Protections

The MPQ3367A provides open LED protection, short LED protection, short LEDx to GND protection, over-current protection, short VOUT to GND protection, and thermal protection. Once the protection is triggered, FF is pulled to GND, and the corresponding fault bit is set to 1. After the IC recovers from a protection, FF is pulled high with a 750μs delay.

Open LED Protection

Open string protection is achieved by detecting the voltage on the OVP pin and LEDx pins. If one string is open during normal operation, the respective LEDx voltage is low to ground, and the IC keeps charging the output voltage until it reaches the over-voltage protection threshold.

If over-voltage protection (OVP) has been triggered, the chip stops switching and marks off the fault string which has a LEDx pin voltage below 100mV. The remaining LED strings force the output voltage back into normal regulation. The string with the largest voltage drop determines the output regulation value. Every 500μs, the string that was marked off sends a 10μs pulse current to check whether the open fault is removed. This means that open string protection is recoverable.

Short String Protection

The MPQ3367A monitors the LEDx voltages to determine whether a short string fault has occurred. If one or more strings are shorted, the shorted LEDx pins tolerate the high voltage stress. If an LEDx voltage exceeds the short protection threshold, an internal counter starts.

If the fault condition lasts for 7.7ms (D_{PWM} = 100%), the fault string is marked off. Once a string is marked off, it disconnects from the output voltage loop until the short condition is removed.

Two methods can set the short protection threshold. The first method is to connect a resistor on the STH pin. STH outputs an 18μA current source. The short protection threshold is 10 times the voltage on STH. The threshold can be calculated with Equation (3):

$$
V_{\text{STH_TH}}(V) = 0.18 \times R_{\text{STH}}(k\Omega) \tag{3}
$$

The second method is to set the internal register (TH_S1:0) when STH is floating.

If all LEDx voltages exceed the threshold for 480ms (D_{PWM} = 100%), all strings are marked off. The IC remains on standby mode until the strings are released from the short condition. Enable or disable this function through SEN.

Every 500μs, the string that was marked off sends a 10μs pulse current to check if the short fault is removed. This means that short string protection is recoverable.

Short LEDx to GND Protection

If LEDx is shorted to GND, the COMP voltage increases and saturates. If COMP is saturated for 40ms, a protection is triggered. FF pulls low, and SD pulls high to turn off the external Pchannel MOSFET. Then the IC latches off.

Short VOUT to GND Protection

When VOUT is shorted to GND, the output voltage decreases. If the voltage on the OVP pin reaches the under-voltage lockout (UVLO) threshold for 10μs, the protection is triggered. SD pulls high to turn off the external P-channel MOSFET. VOUT disconnects from VIN, and the IC latches off.

Cycle-by-Cycle Current Limit

To prevent the external components from exceeding the current stress rating, the IC has cycle-by-cycle current limit protection. When the current exceeds the current limit value, the internal low side MOSFET turns off until the next clock cycle.

Latch-Off Current Limit Protection

The device can be damaged by extreme conditions, such as an inductor or diode short to GND. To avoid this, the MPQ3367A provides latch-off current limit protection. If the current flowing through the internal MOSFET reaches 7.5A, and lasts for 5 switching cycles, current limit protection is triggered.

Thermal Protection

To prevent the IC from operating at exceedingly high temperatures, the MPQ3367A implements thermal protection by detecting the silicon die temperature.

Over-Temperature LED Current Decrement

If the die temperature exceeds 140°C, the MPQ3367A automatically decreases the LED current amplitude (see Figure 6).

Figure 6: ILED Decreases with Temperature

This function is enabled by the overtemperature current decrement bit (OTID).

- \bullet When OTID = 0, the over-temperature current decrement is disabled.
- \bullet When OTID = 1 (default), the overtemperature current decrement is enabled.

Thermal Shutdown

If the die temperature exceeds the upper threshold (T_{ST}) , the IC shuts down. When the temperature drops below the lower threshold, the IC recovers. The typical hysteresis value is 20°C.

I ²C Interface

I ²C Chip Address

The 7-bit MSB device address is 0x38~0x3A. This address can be selected through the ADR pin. When the ADR pin is floating, the IC address is 0x38. When ADR < 0.4V, the IC address is 0x3A. When ADR is between 0.4V and 1.4V, the IC address is 0x39. The ADR pin's pull-up current is 18µA.After the start condition, the I ²C-compatible master sends a 7-

bit address followed by an eighth read (1) or write (0) bit.

Figure 7 shows an I ²C-compatible device address.

Figure 7: I 2C-Compatible Device Address

REGISTER MAP

If using the internal registers, float the corresponding pins.

Function Set Register 1

Function Set Register 2

MPQ3367A – 6-CHANNEL WLED DRIVER WITH HIGH DIM RATIO AND I ²C, AEC-Q100

Fault Register

ID Register

APPLICATION INFORMATION

LED Current Setting

The LED current amplitude is set by an external resistor connected from ISET to GND. The LED current amplitude can be calculated with Equation (4):

$$
I_{LED}(mA) = \frac{1245}{R_{SET}(k\Omega)}\tag{4}
$$

For example, if $R_{ISET} = 24.9kΩ$, the LED current is 50mA.

Switching Frequency

The switching frequency can be configured by a resistor, I²C interface, or external clock.

To configure the frequency with an external resistor on FREQ/SYNC, the switching frequency can be estimated with Equation (5):

$$
f_{SW}(kHz) = \frac{22000}{R_{FREG}(k\Omega)}\tag{5}
$$

For example, if $R_{FREQ} = 44.2k\Omega$, the switching frequency is set to 500kHz.

If setting the switching frequency via the I^2C interface, float the FREQ/SYNC pin. The FSW1:0 bits have the following options:

- 00: 200kHz
- 01: 400kHz
- 10: 1MHz
- 11: 2.2MHz

Selecting the Input Capacitor

The input capacitor reduces the surge current drawn from the input supply, as well as the switching noise from the device. Use ceramic capacitors with X5R or X7R dielectrics due to their low ESR and small temperature coefficients. For most applications, a 10μF ceramic capacitor is sufficient.

Selecting the Inductor

The MPQ3367A requires an inductor to supply a higher output voltage while being driven by the input voltage. A larger-value inductor results in less ripple current, lower peak inductor current, and less stress on the internal Nchannel MOSFET. However, a larger-value inductor has a larger physical size, higher series resistance, and lower saturation current.

Choose an inductor that does not saturate under the worst-case load conditions. Select the minimum inductor value to ensure that the boost converter works in continuous conduction mode (CCM) with high efficiency and good EMI performance.

Calculate the required inductance value using Equation (6):

$$
L \geq \frac{\eta \times V_{\text{out}} \times D \times (1-D)^2}{2 \times f_{\text{sw}} \times I_{\text{LOD}}}
$$
 (6)

Where V_{OUT} is the output voltage, I_{LOAD} is the LED load current, η is the efficiency, f_{SW} is the switching frequency, and D can be estimated with Equation (7):

$$
D = 1 - \frac{V_{IN}}{V_{OUT}} \tag{7}
$$

Where V_{IN} is the input voltage.

With the given inductor value, the inductor DC current rating should be at least 40% greater than the maximum input peak inductor current for most applications. The inductor's DC resistance should be as small as possible for higher efficiency.

Selecting the Output Capacitor

The output capacitor keeps the output voltage ripple small and ensures feedback loop stability. Ceramic capacitors with X7R dielectrics are recommended for their low-ESR characteristics. For most applications, a 10μF ceramic capacitor is sufficient.

Selecting the Over-Voltage Protection (OVP) Threshold

Open string protection is achieved by monitoring the voltage on the OVP pin. An LED string failure can result in the feedback voltage dropping to 0. If this occurs, the MPQ3367A continues boosting the output voltage until it reaches the configured OVP threshold. Then OVP is triggered.

Select appropriate values for the OVP pin's resistor divider to set the OVP threshold. The recommended OVP threshold is about 1.1 to 1.2 times the output voltage under normal operation.

The OVP threshold can be estimated with Equation (8):

$$
V_{_{OVP}} = 2 \times (1 + \frac{R_{_{OVP_HIGH}}}{R_{_{OVP_LOW}}})
$$
 (8)

Where R_{OVP HIGH} is the OVP pin's high-side resistor, and $R_{\text{OVP LOW}}$ is the OVP pin's low-side resistor.

PCB Layout Guidelines

Careful attention must be given to the PCB layout and component placement. Efficient placement of the high-frequency switching path is critical to prevent noise and electromagnetic interference. For the best results, refer to Figure 8 and follow the guidelines below:

- 1. Connect the IC's exposed pad to the AGND pin, and ensure that all logic signals are referred to AGND.
- 2. Externally connect PGND to AGND. Route PGND away from the logic signals.
- 3. Keep the loop between the SW and PGND pin, output diode (D1), and capacitors (C1 and C2) as short as possible due to the high-frequency pulse current.

Figure 8: Recommended PCB Layout

TYPICAL APPLICATION CIRCUIT

Figure 9: Typical Application Circuit

QFN-24 (4mmx4mm)

PACKAGE INFORMATION

TOP VIEW

RECOMMENDED LAND PATTERN

NOTE:

1) ALL DIMENSIONS ARE IN MILLIMETERS. 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH. 3) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX. 4) JEDEC REFERENCE IS MO-220 5) DRAWING IS NOT TO SCALE.

PACKAGE INFORMATION

QFN-24 (4mmx4mm) WF

TOP VIEW

BOTTOM VIEW

SIDE VIEW

RECOMMENDED LAND PATTERN

NOTE:

1) THE LEAD SIDE IS WETTABLE. 2) ALL DIMENSIONS ARE IN MILLIMETERS. 3) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX. 4) JEDEC REFERENCE IS MO-220. 5) DRAWING IS NOT TO SCALE.

CARRIER INFORMATION

REVISION HISTORY

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